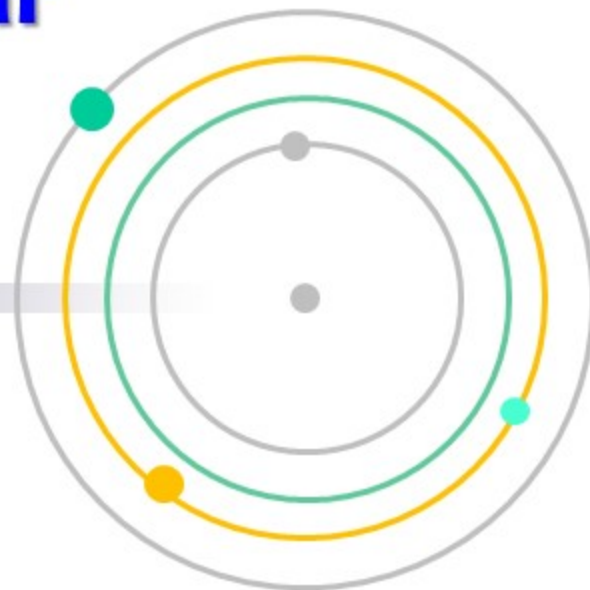


EMC Technical Seminar



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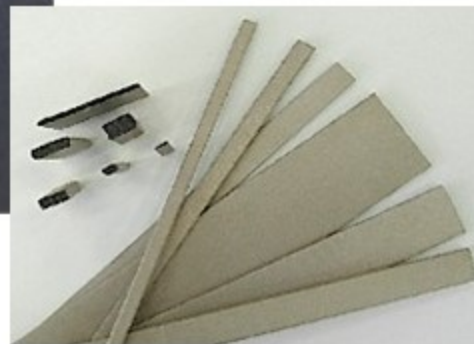
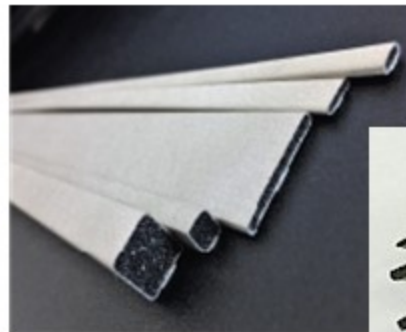
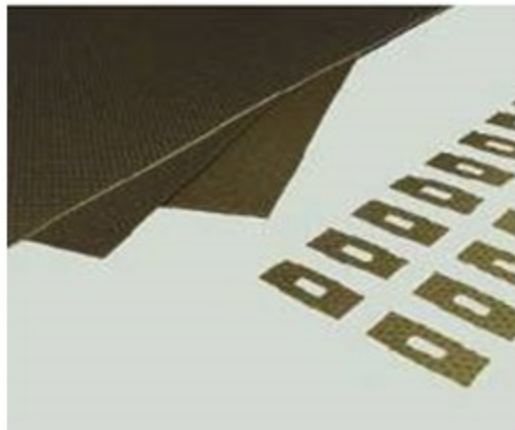
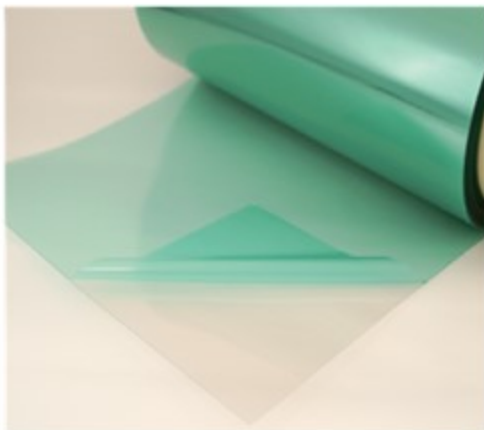
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Contents

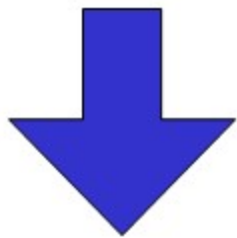
1. Fundamentals of EMC
2. Shielding Techniques and Components
3. Grounding Techniques and Components
4. Filtering Techniques with Ferrite Cores

Shielding with Low Impedance Material



Radiation of Electromagnetic Waves

- Openings of enclosure
- Cables
- PCB



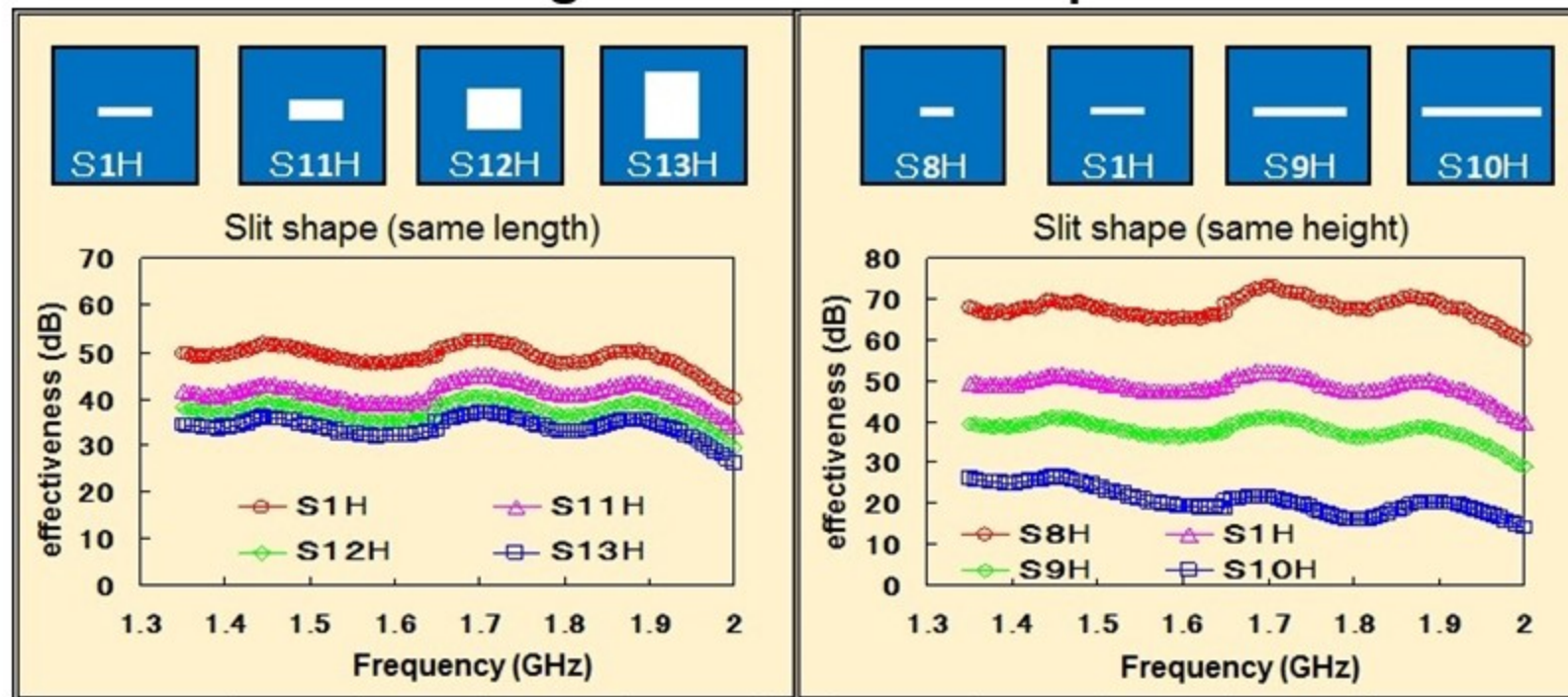
Reduce radiation by **Shielding**



Shielding helps prevent electromagnetic waves from exiting or entering the enclosure.

Aperture size affects Shielding Effectiveness

Shielding Effectiveness Comparison



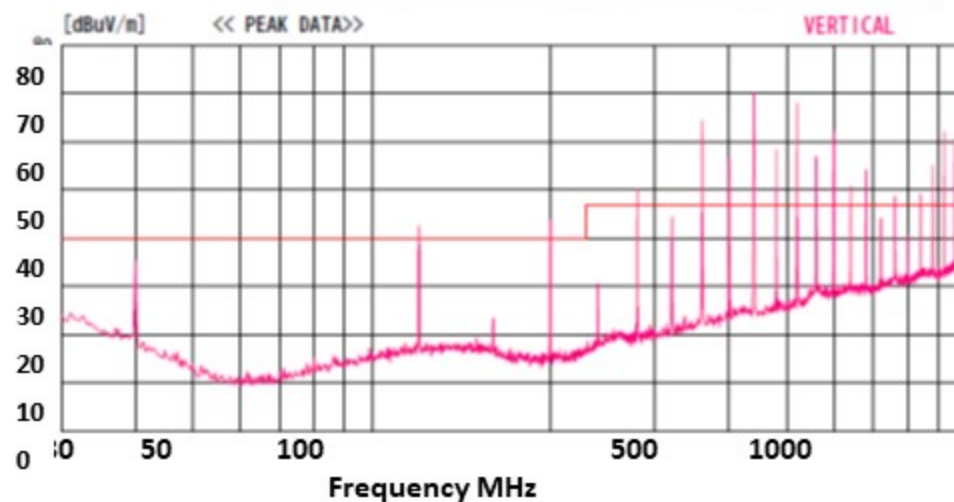
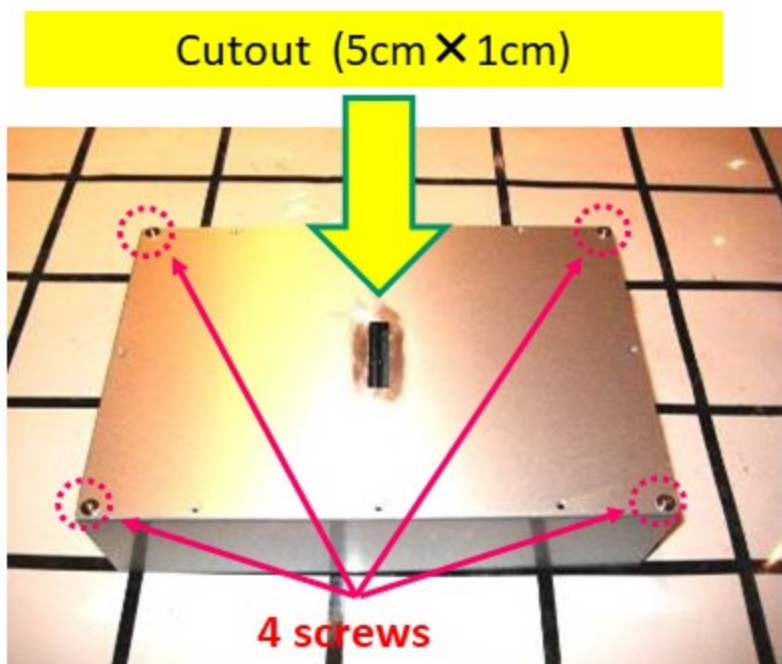
	Length (mm)	height (mm)	size (cm ²)			length (mm)	height (mm)	size (cm ²)
S1H	34.0	2.0	0.7		S8H	17.0	2.0	0.3
S11H	34.0	10.0	3.4		S1H	34.0	2.0	0.7
S12H	34.0	20.0	6.8		S9H	50.0	2.0	1.0
S13H	34.0	34.0	11.6		S10H	75.0	2.0	1.5

The maximum dimension has more influence on shielding effectiveness.

Aperture size affects Shielding Effectiveness

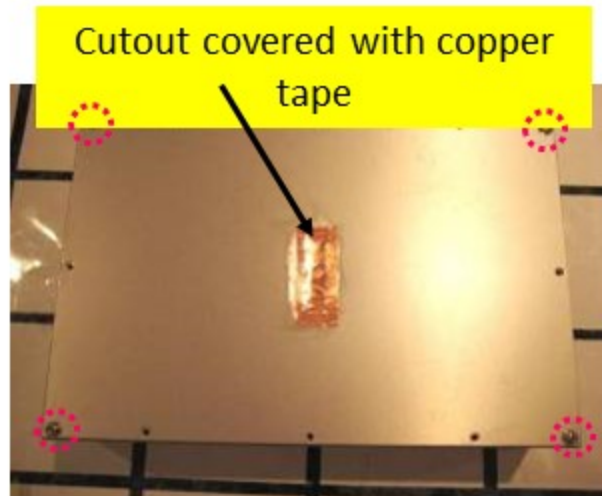
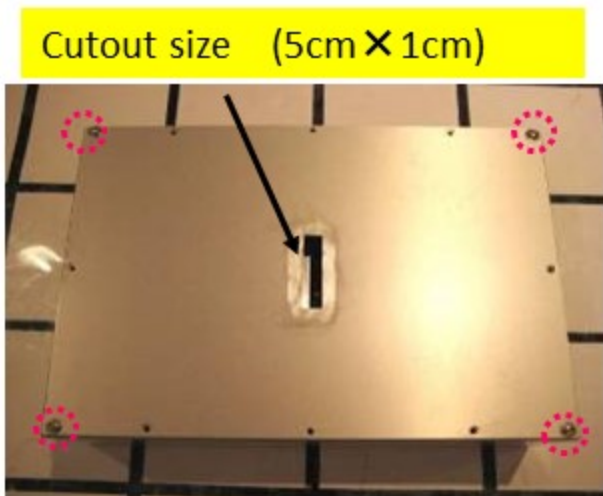
Test box:

1. Aluminum case
2. Dimensions: W250 × D180 × H70 (mm)
3. Surface treatment: alumite (non-conductive)

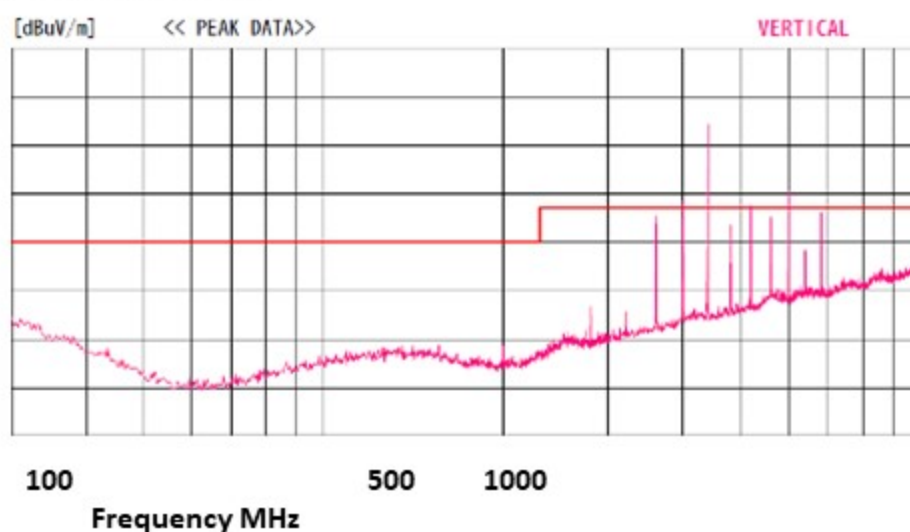
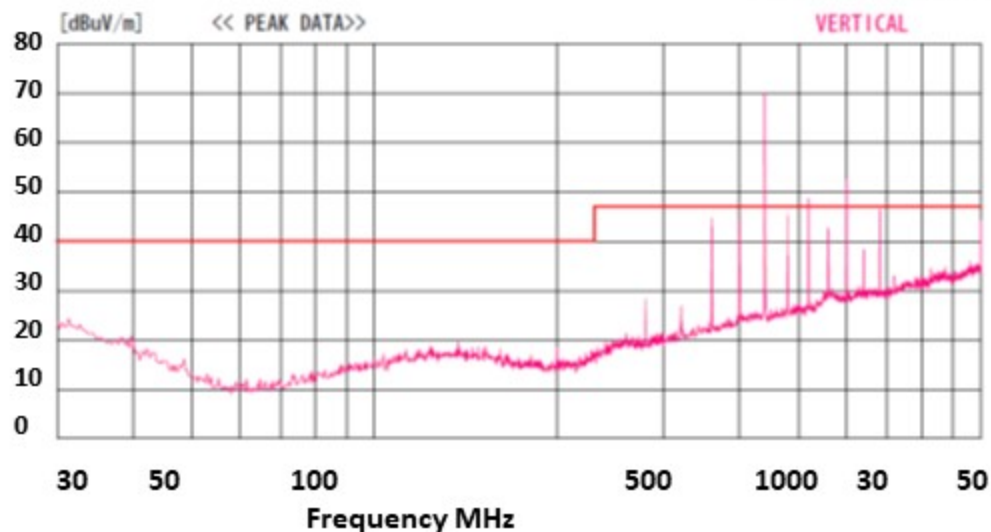


Noise emission in vertical polarization **without a lid**

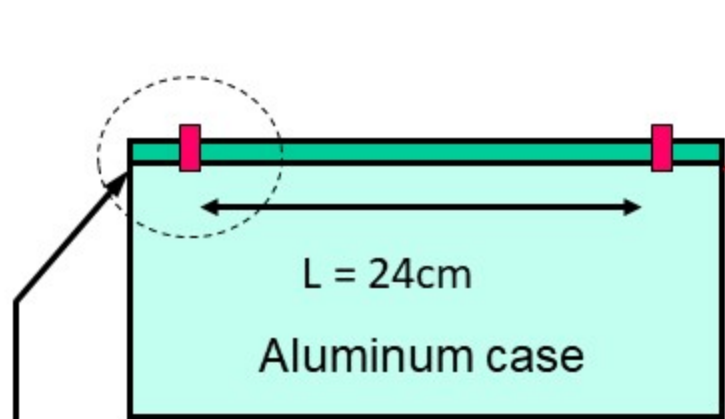
Aperture size affects Shielding Effectiveness



No significant improvement



Aperture size affects Shielding Effectiveness



Joint at the lid formed a longer slit than the cutout on the lid.

Since the cover is coated with alumite, electrical conductivity through the lid is only at screw points.



Long slits are created between the screws.



Shielding effectiveness is greatly reduced.



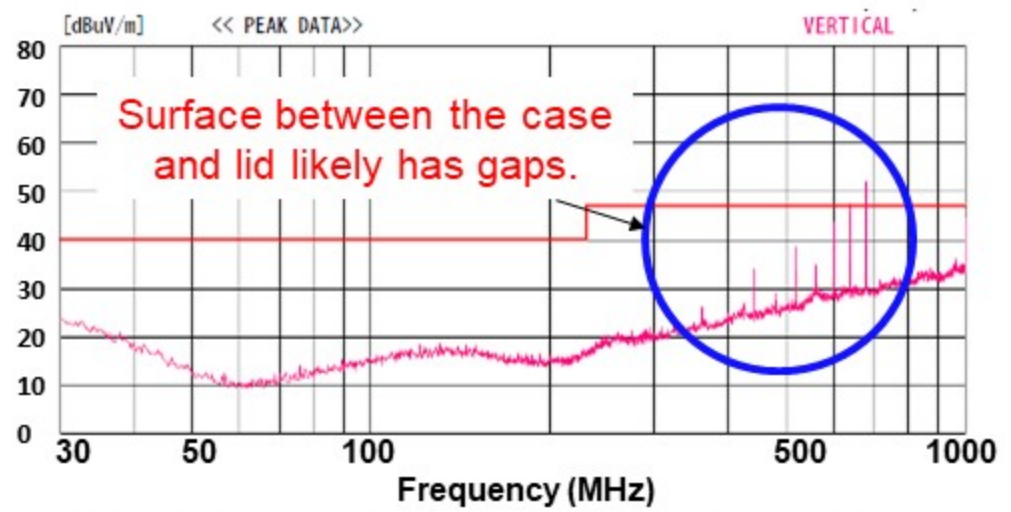
Shielding effect of a slit

$$SE(dB) = 20 \text{Log} \left(\frac{\lambda}{2L} \right)$$

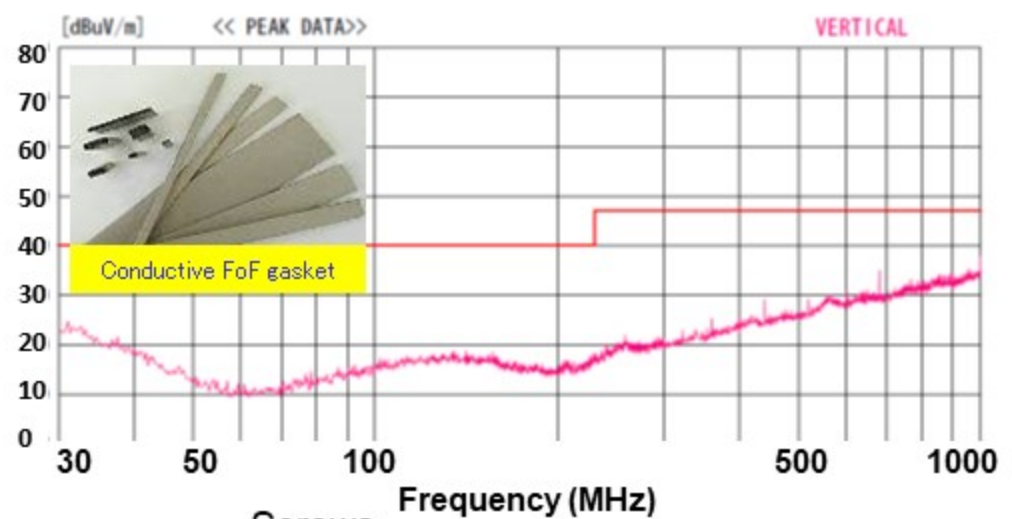
λ : Wave length (m)
 L: largest opening measurement (m)

Sealing Slits on Enclosures with Shielding Gaskets

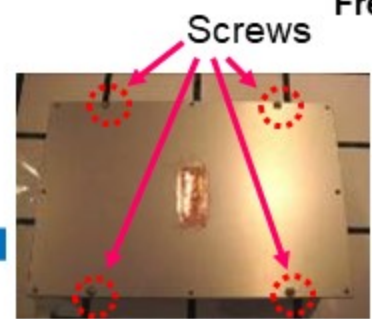
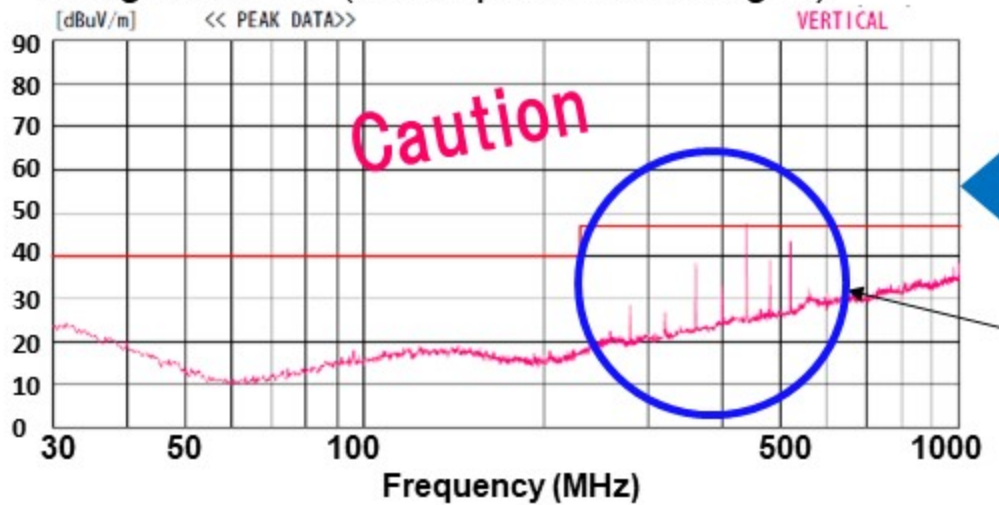
Non-conductive coating removed



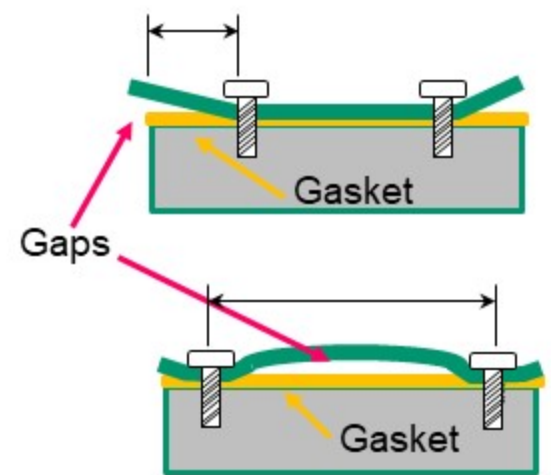
Using Gaskets (entire slit)



Using Gaskets (screw positions changed)

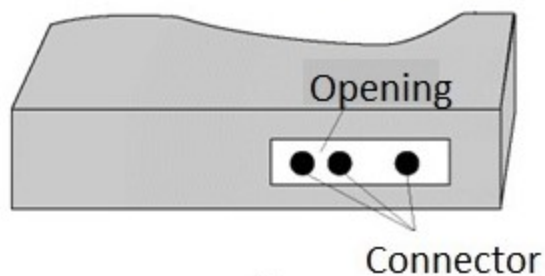


Due to repelling force of the gasket, it does not attach well to the lid and can potentially warp and create gaps around the screws.

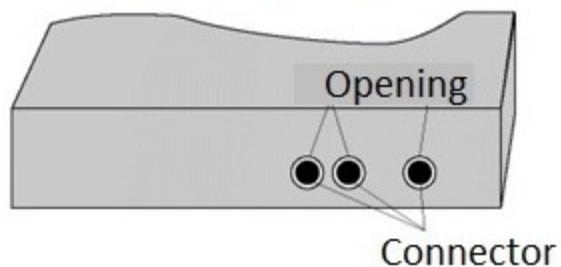


Recommended Shielding Design

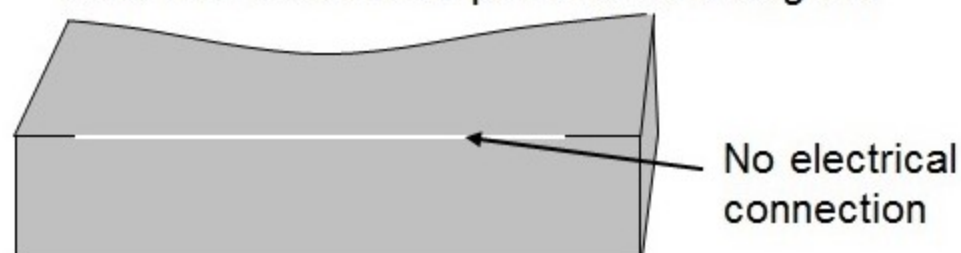
Bad: overall opening is large



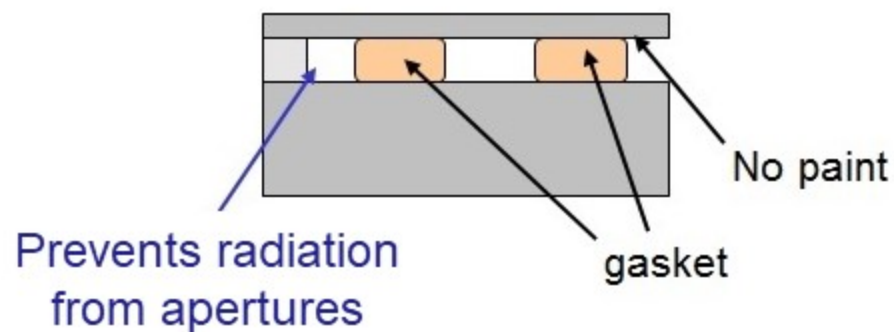
Good: overall opening is small



Bad: Non-conductive paint forms a long slit



Good: paint removed, gasket used



Slit should be less than 1/10 of the wavelength

$$\lambda(m) = 300 / f(MHz)$$



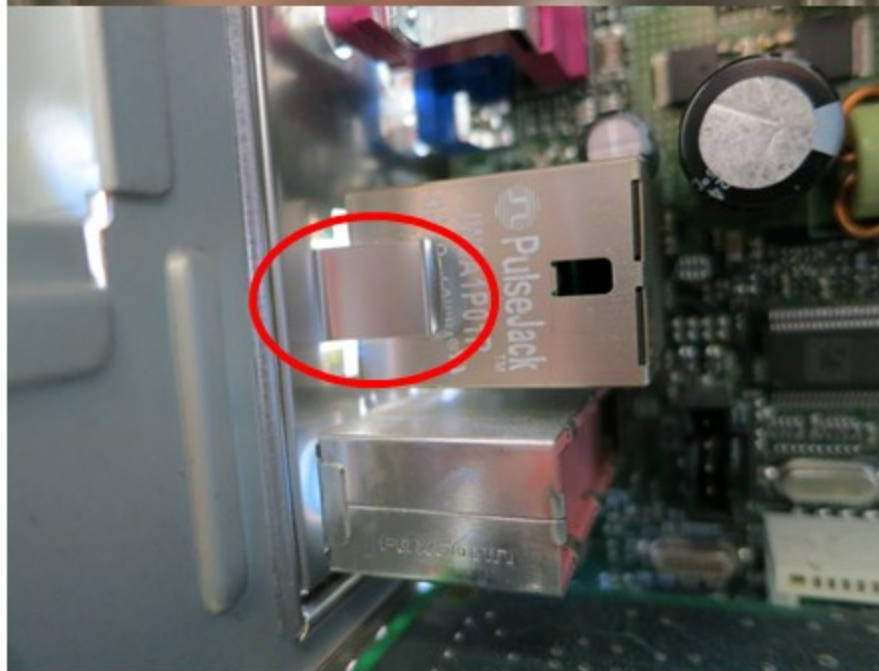
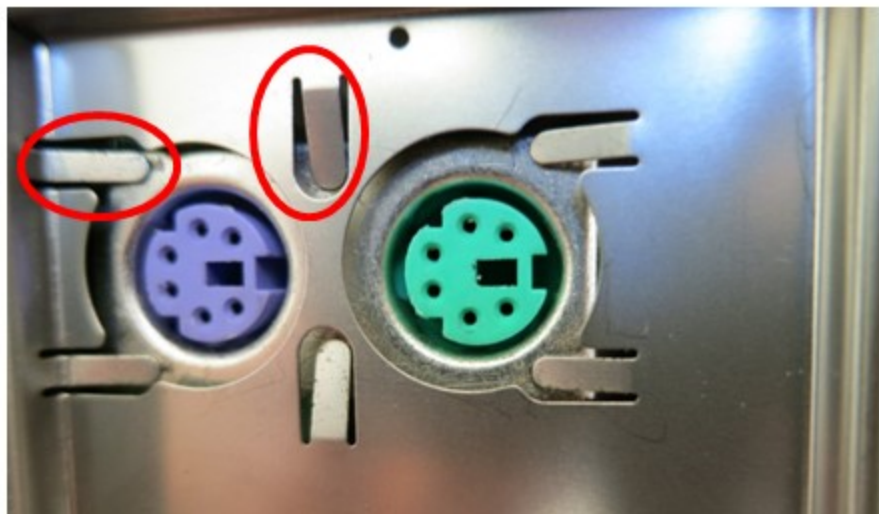
In this example of a desktop computer, one could assume that the noise would leak from the blue areas, as there are many holes for the noise to escape from.



However, the areas in red would be the real points of concern.



Taking a closer look by removing the side wall, we can see that contact points were built in, with a small pitch between each point, to ensure the length is not over $1/10^{\text{th}}$ the distance of the wave length.

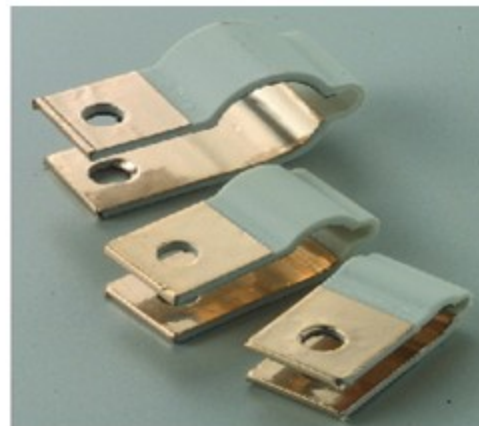
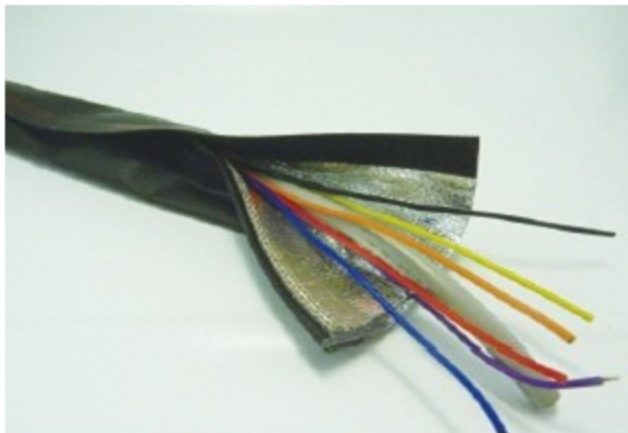


Same care was taken when designing the face plate for the I/O area and the small fingers, ensuring there is a contact and frame ground.

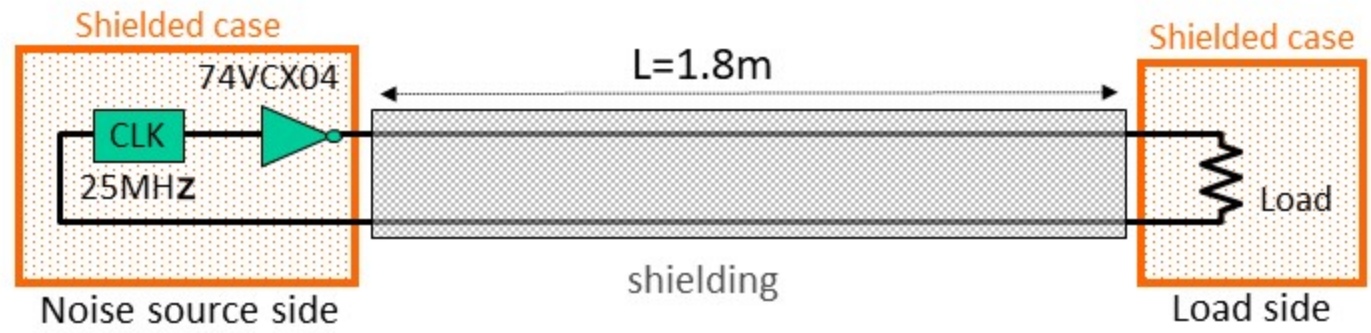


If noise is still leaking, it would most likely be from these two points, where such care was not taken in the design.

Cable Shielding



Cable Shielding Test



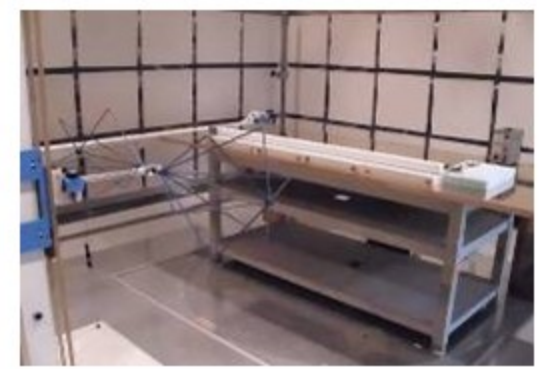
Noise Emission comparison among different grounding methods

- Shielded but not ground
- Shielded and ground to noise source side only
- Shielded and ground to load side only
- Shielded and ground to both sides with grounding wires
- Shielded and ground to both sides with grounding clamps

Site setup 150kHz-30MHz



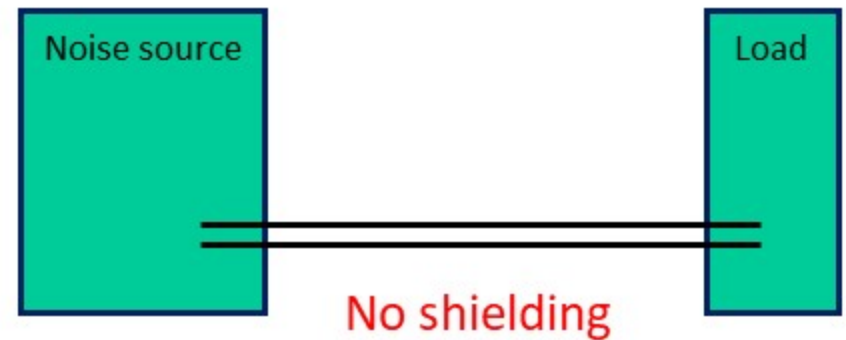
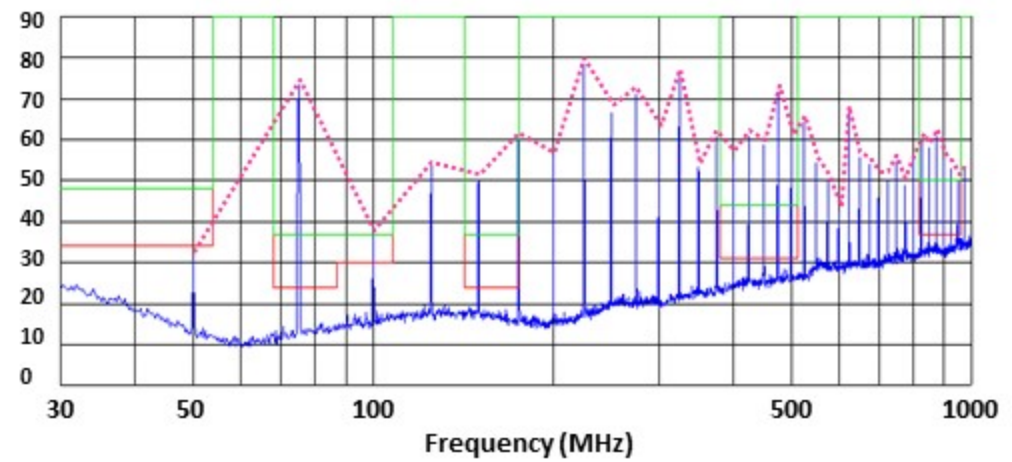
Site setup 30MHz-300MHz



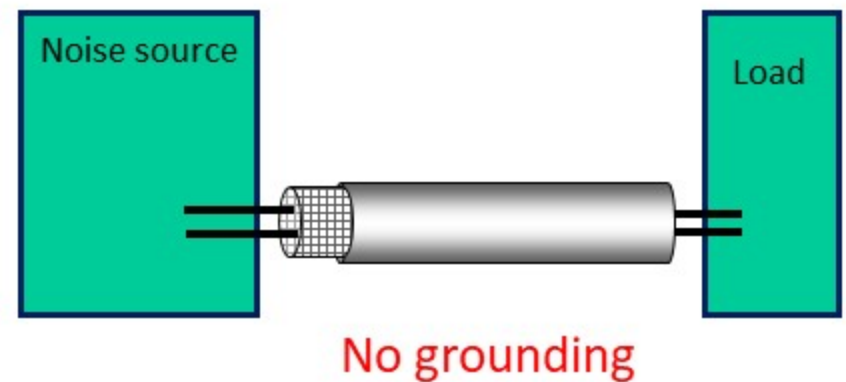
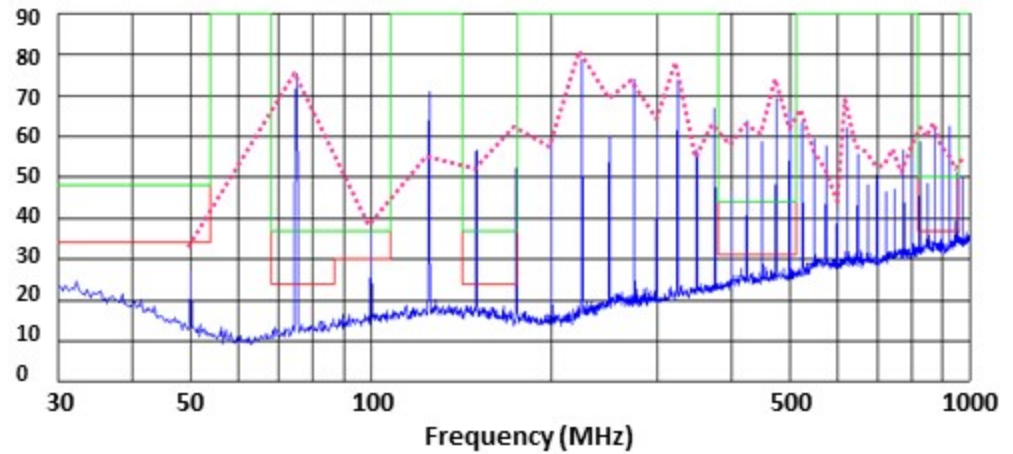
※ Tested by CISPR25 Class3 method
 (for over 30MHz, measured with horizontal polarization only)

Cable Shielding Effectiveness: 30MHz ~ 1000MHz

No shielding

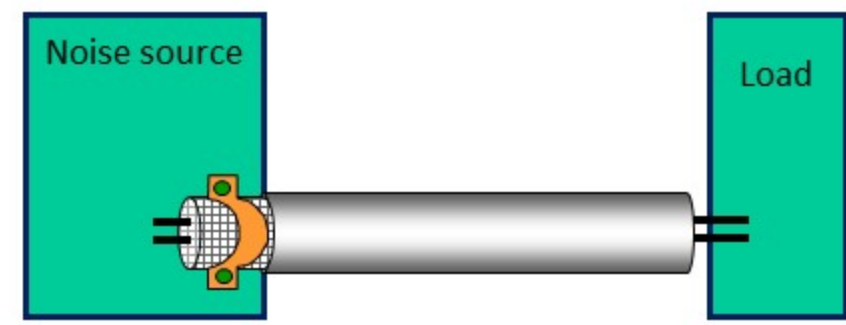
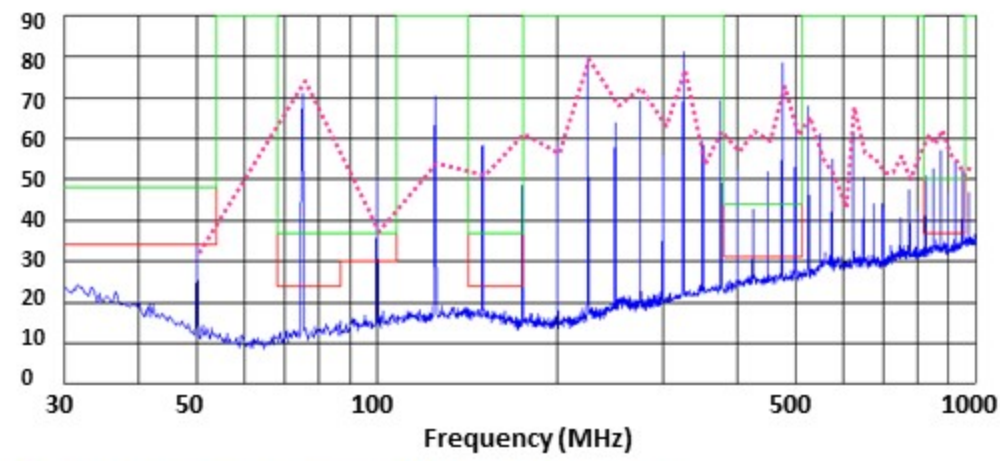


Shielded but not ground



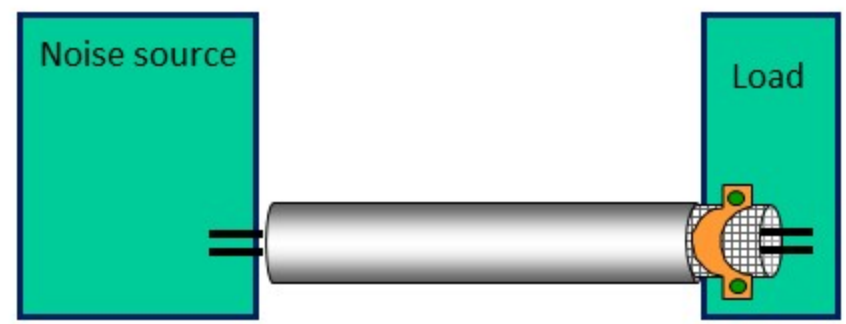
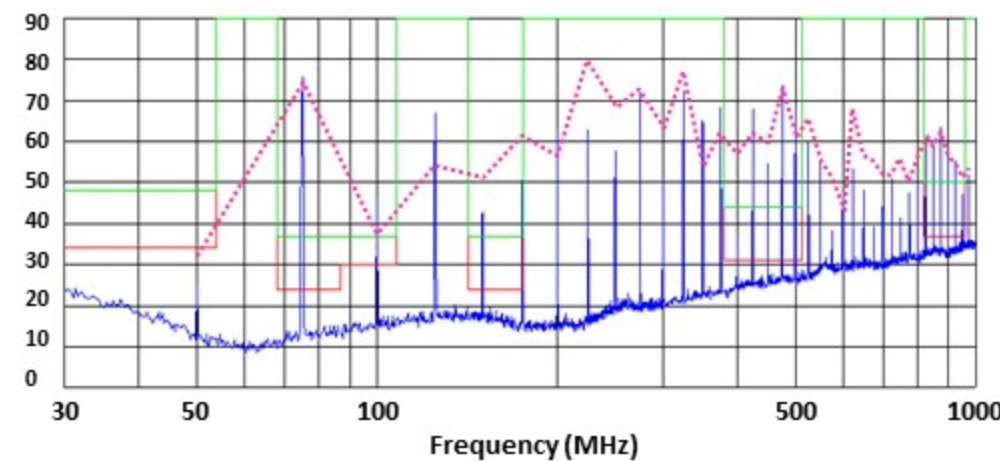
Cable Shielding Effectiveness: 30MHz ~ 1000MHz

■ Shielded and ground to noise source side only



Ground with 360° clamp
Noise source side

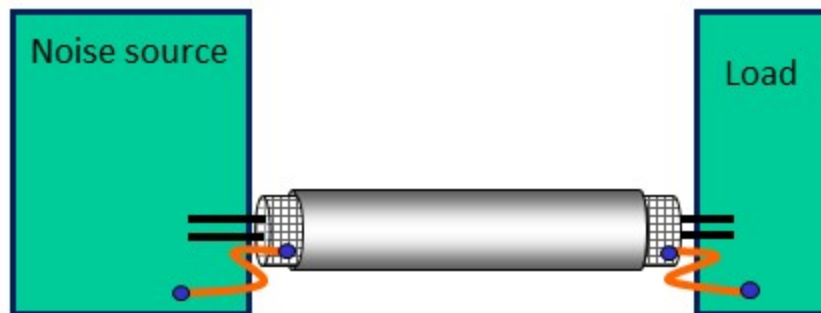
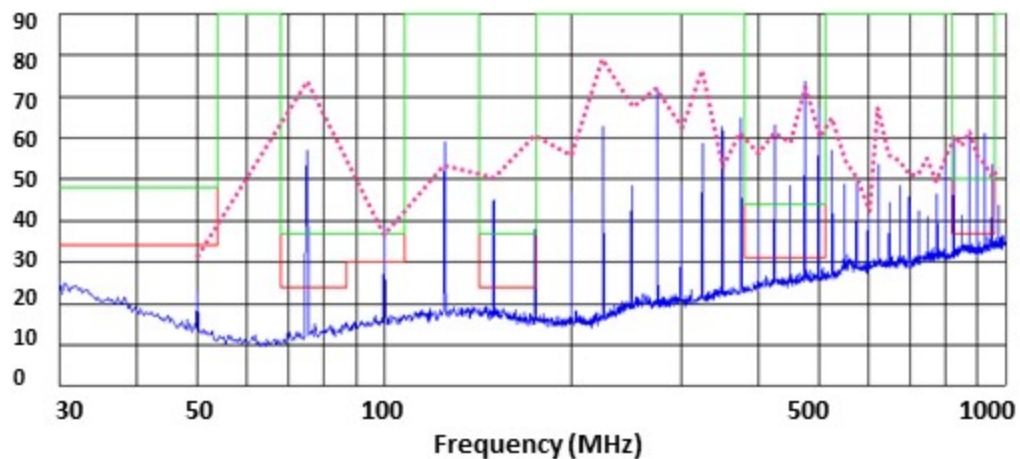
■ Shielded and ground to load side only



Ground with 360° clamp
Load side

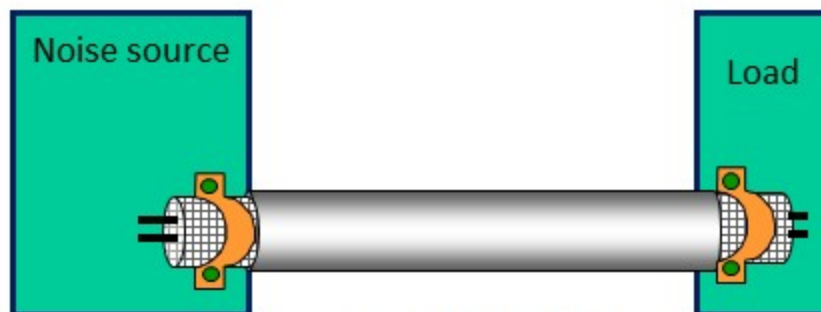
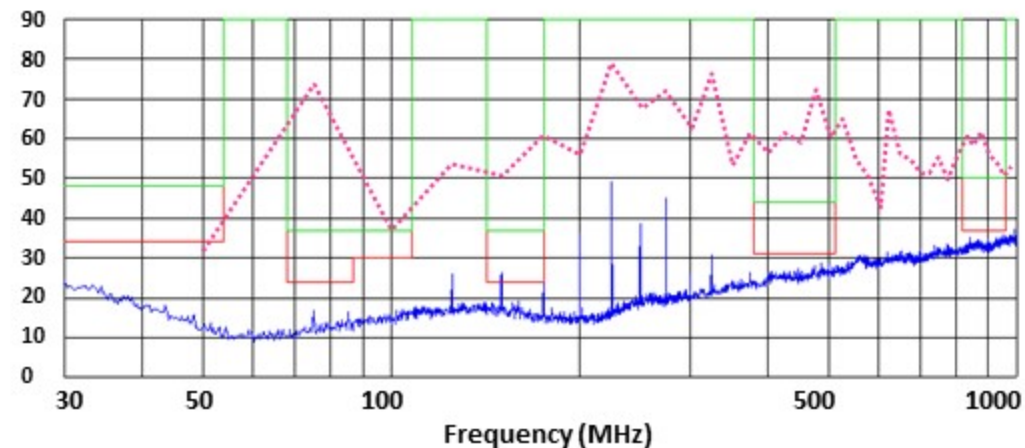
Cable Shielding Effectiveness: 30MHz ~ 1000MHz

Shielded and ground to both sides with grounding wires



Ground with pigtail wires

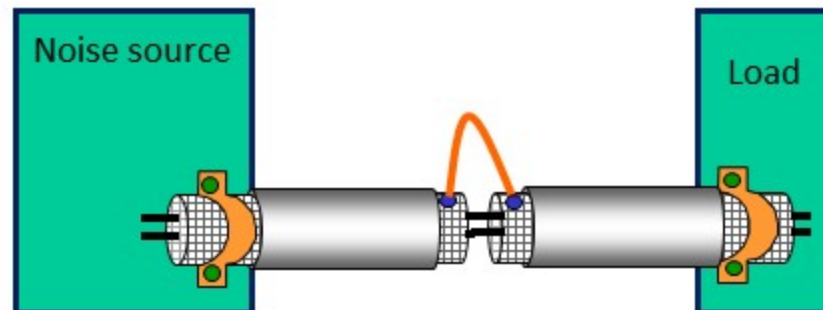
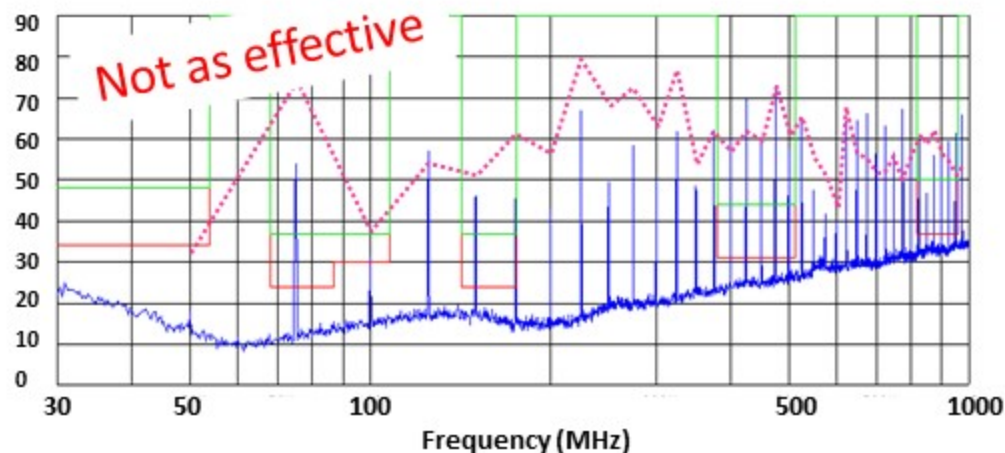
Shielded and ground to both sides with grounding clamps



Ground with 360° clamps
Both sides

Cable Shielding Effectiveness: 30MHz ~ 1000MHz

■ Two shields ground at either end and connected with wire



Ground with 360° clamps with center break connected with a wire

Plastic Cable Grounding Example:

- Grounds and fixes cables at the same time
- Does not damage cables (compared to metal clamps)

Cable grounding clamps



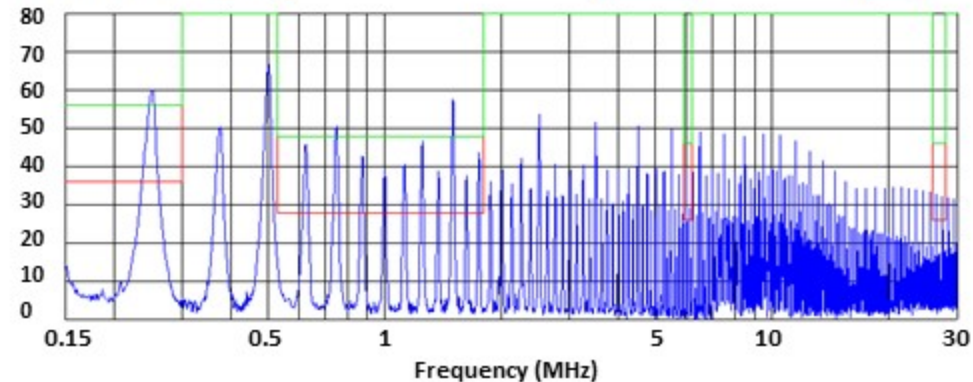
Screw-mount



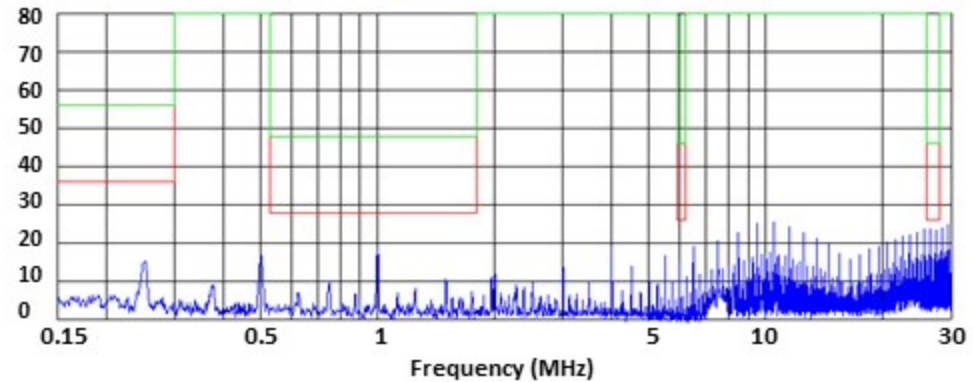
Snap-mount

Cable Shielding Effectiveness: 150kHz ~ 30MHz

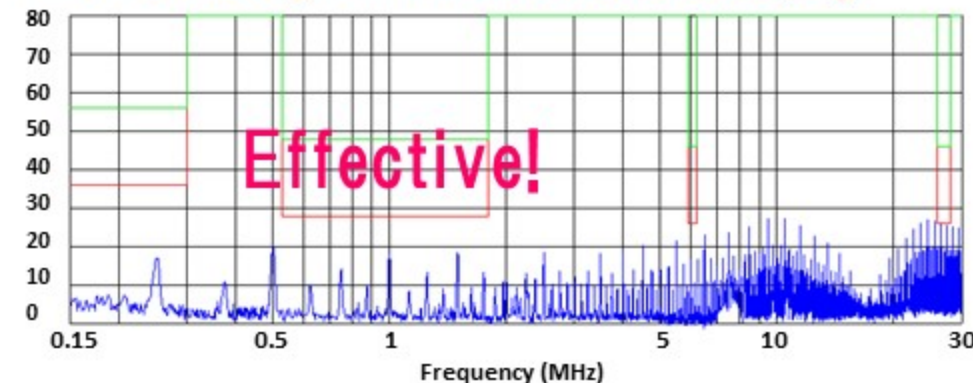
■ No shielding



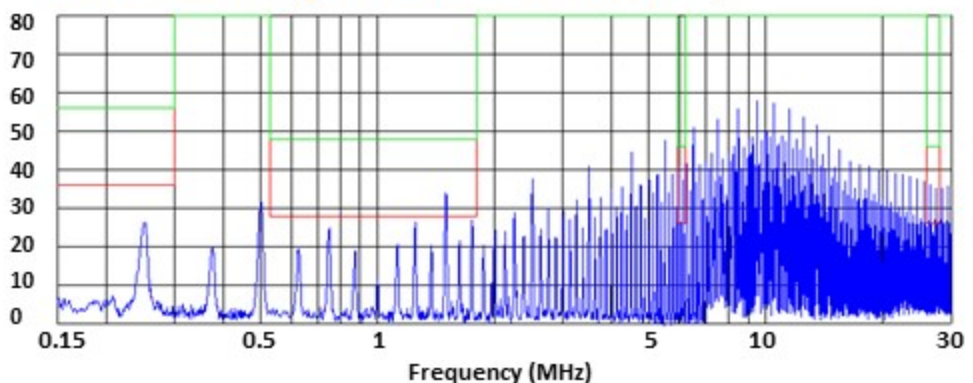
■ Shielded & ground on both sides



■ Shielded & ground on **noise source side only**

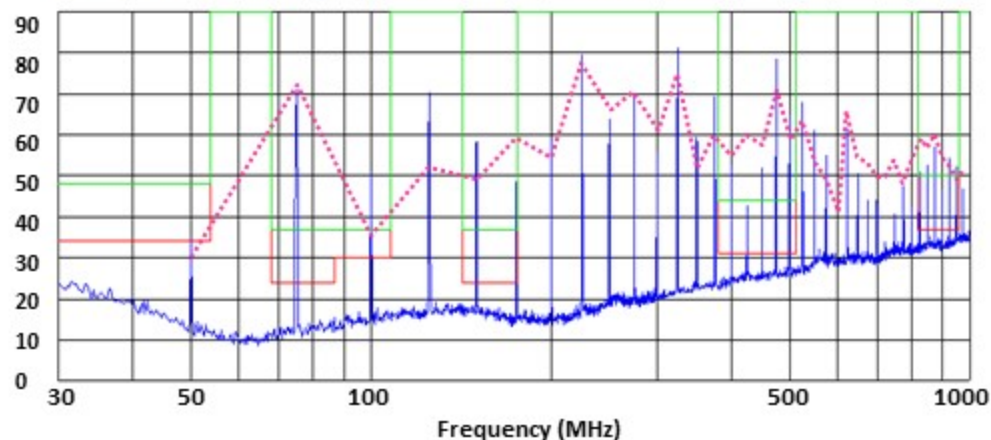


■ Shielded & ground on **load side only**

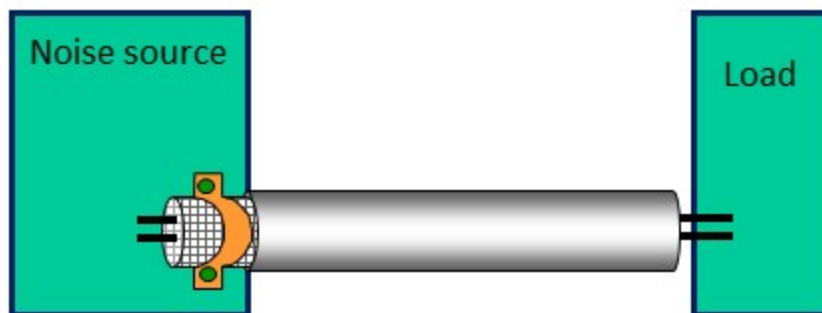
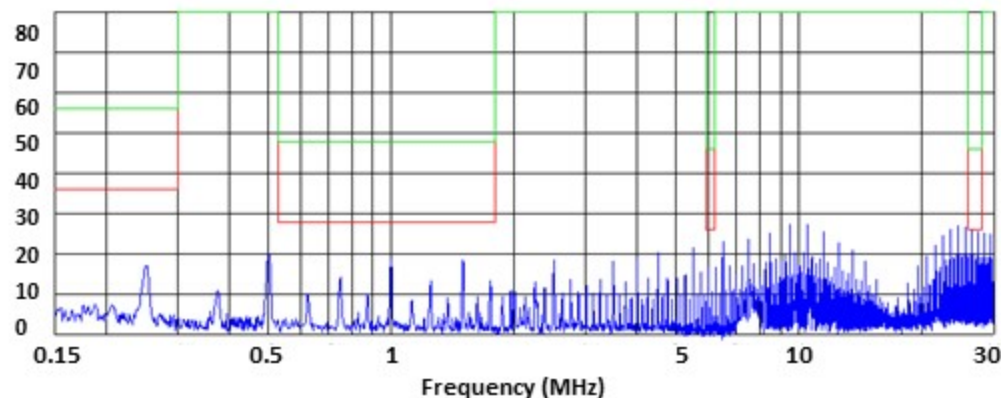


Ground to Noise Source Side

■ High Frequency (30MHz ~ 1000MHz)



■ Low Frequency (150kHz ~ 30MHz)



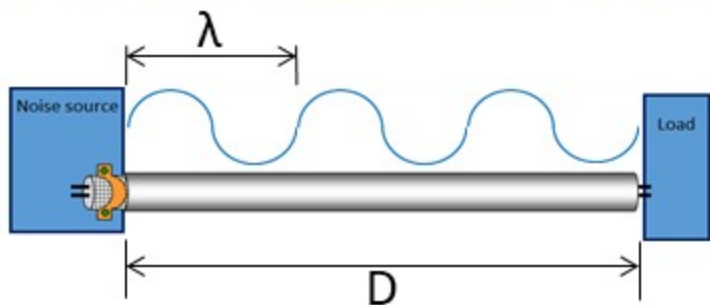
Ground with 360° clamp
Noise source side

Why did grounding only on the noise source side of the cable work for low frequency test?

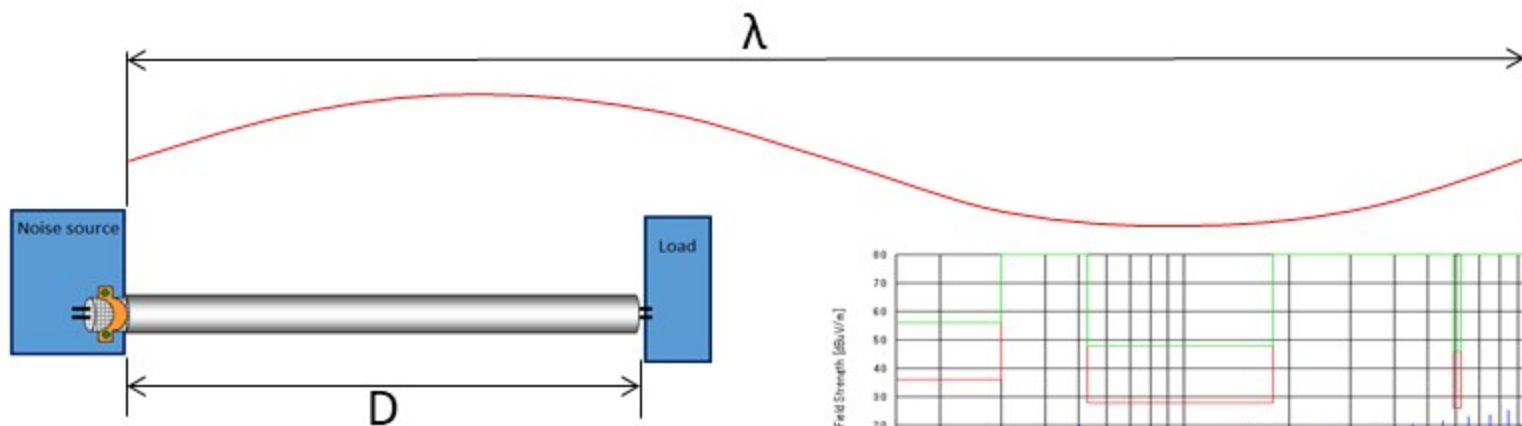
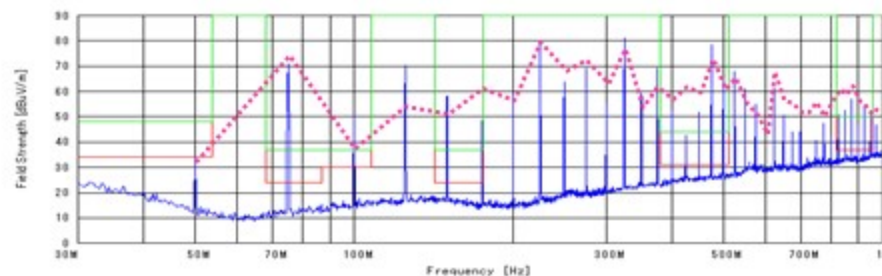
Wavelength vs Cable Length

Ground with 360° clamp (noise source side)

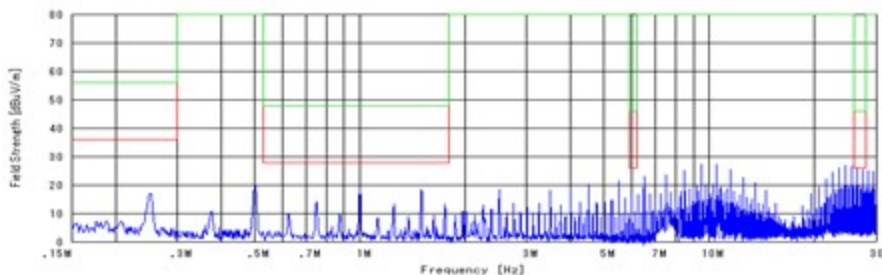
Relationship between the cable length (D) to the problem frequency's wavelength (λ) directly affects the cable shield's effectiveness.



If $D > \lambda$, shielding effectiveness is poor



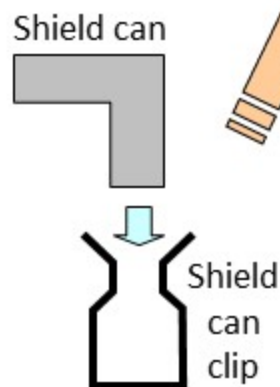
If $D < \lambda$, shielding effectiveness is GOOD



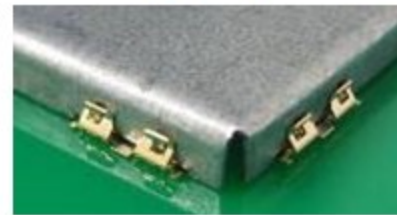
On-Board Grounding Clips for Shield Cans

Shield cans prevent:

- EM radiation from the IC
- Susceptibility to EM emissions from other sources



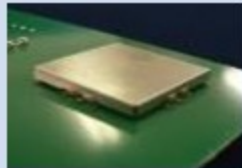

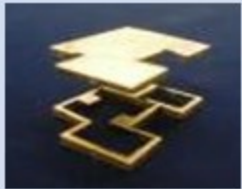
Board-level grounding clips



Features

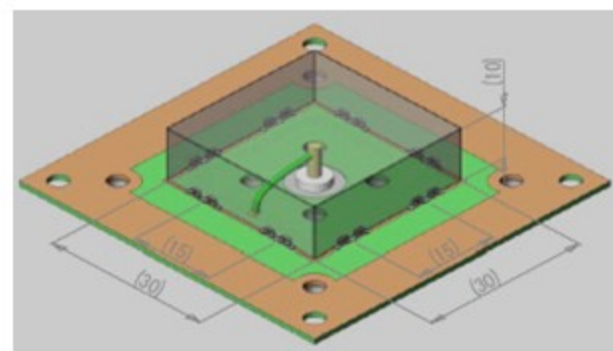
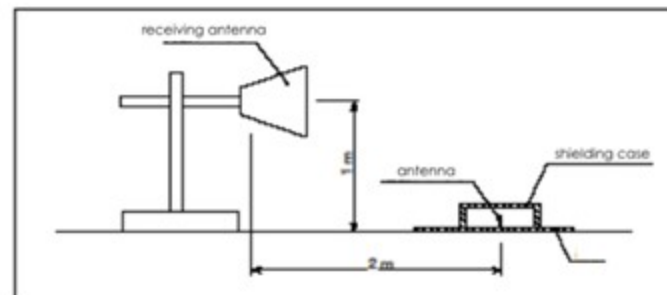
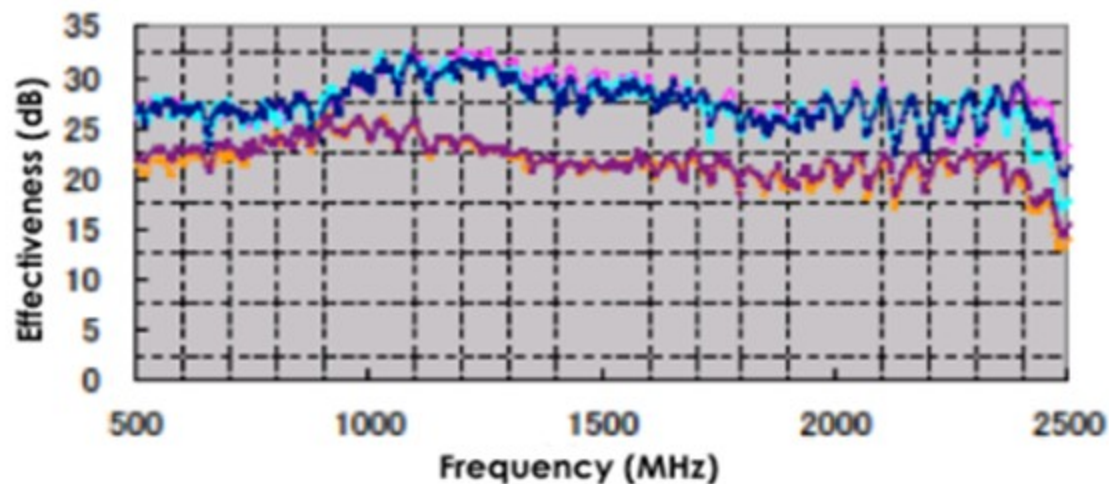
- ◆ Same effect as soldering
- ◆ Easier maintenance, including mounting check
- ◆ Maximize use of PCB space
- ◆ Small footprint

Options for Attaching Shielding Can

Shield Can + Mounting Options	Image	Advantages	Disadvantages
Shield Can + Shield Can Clip		<ol style="list-style-type: none"> 1) Easy inspection and maintenance 2) Low manufacturing and parts costs 3) Effective use of available space on PCB (less dead space) 4) No added tooling cost 	<ol style="list-style-type: none"> 1) May increase number of pieces required
Shield Can + Perimeter Solder		<ol style="list-style-type: none"> 1) Fewer parts to track 2) Best shielding performance if can is 100% perimeter soldered 	<ol style="list-style-type: none"> 1) Requires special coating on shield can for soldering process 2) Solder must be broken for maintenance, high potential for board/ component damage 3) Can take long time for service and maintenance
Shield Can + Fence		<ol style="list-style-type: none"> 1) Easy maintenance and inspection 	<ol style="list-style-type: none"> 1) Two tooling charges 2) Poor use of space 3) Difficult to rework 4) Difficult to reduce product height

Shielding Effectiveness Comparison

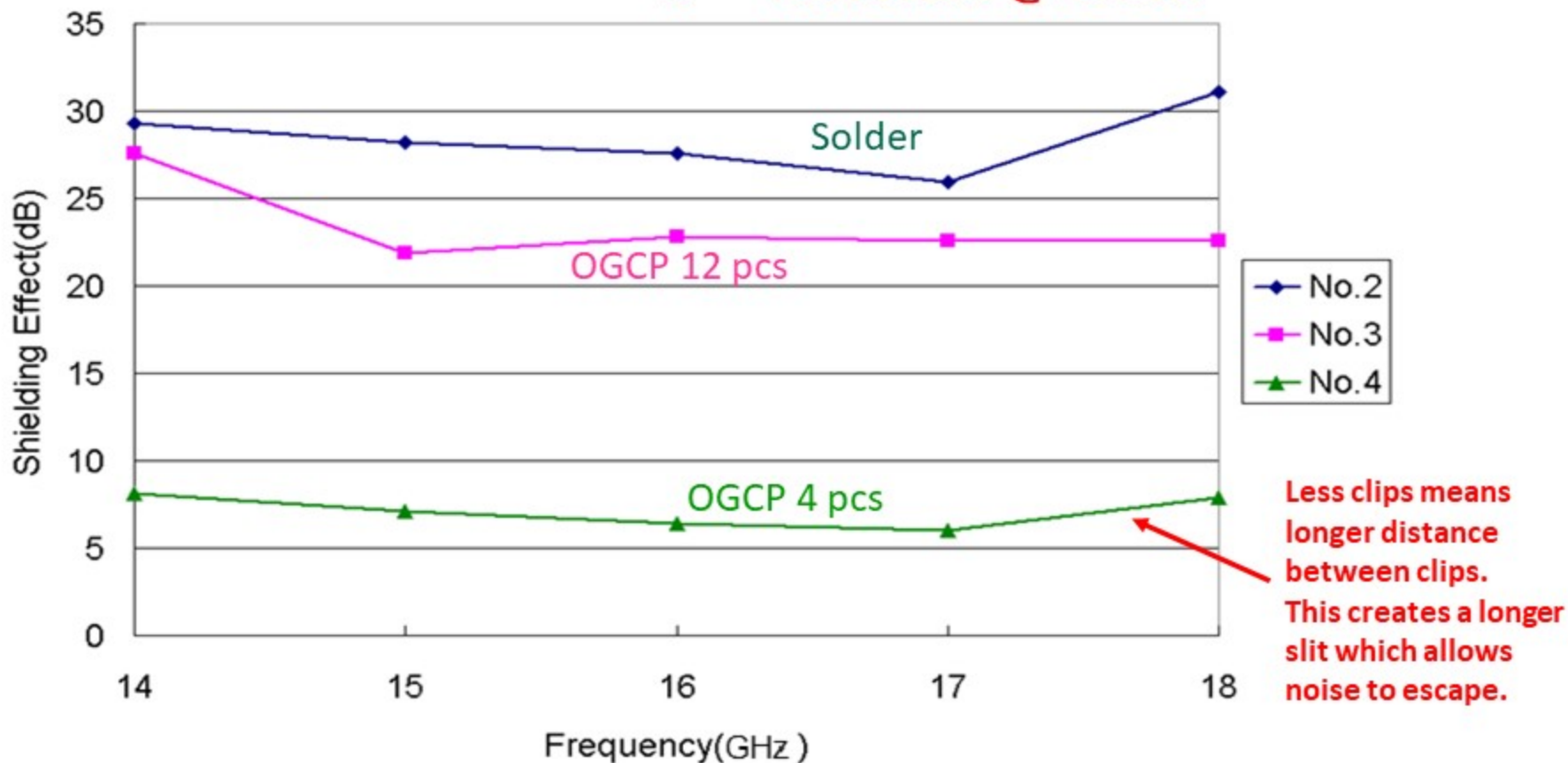
- Compare solder vs. shield can clips (OGCP) between 500MHz ~ 2.5 GHz
- 4 pts of solder vs 4 pts of OGCP yield similar shielding effectiveness
- Perimeter solder vs 8 pts OGCP yield similar results



When connected at same contact point, soldering and OGCP have the same shielding effect.

Shielding Effectiveness at 16GHz

$\lambda = 18.75\text{mm @16GHz}$



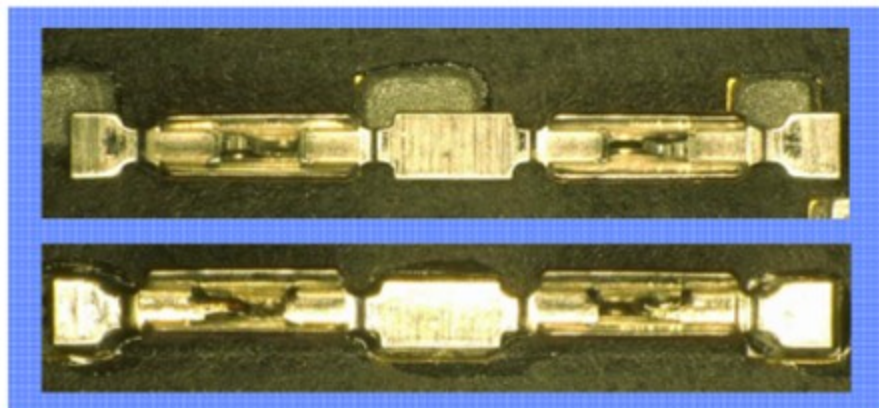
Recommended distance between grounding points is less than 1/10 wavelength (λ).

Reflow Process

- Clips are designed to be self-aligning.
- Even if the placement is off-center or tilted, the clips self-correct onto the solder pad during the reflow process.



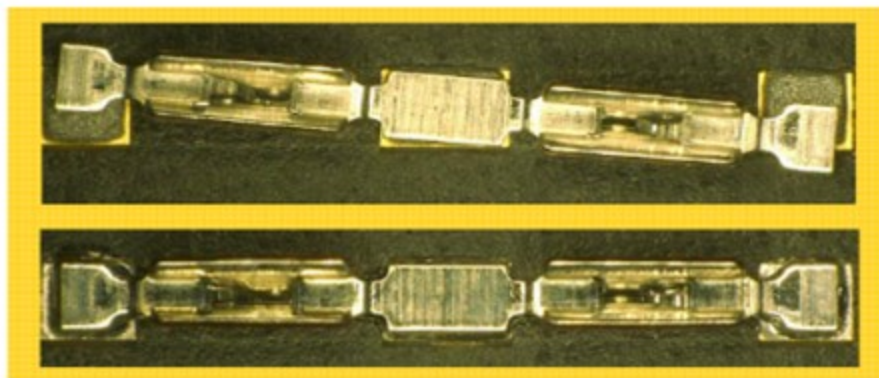
Before reflow



After reflow



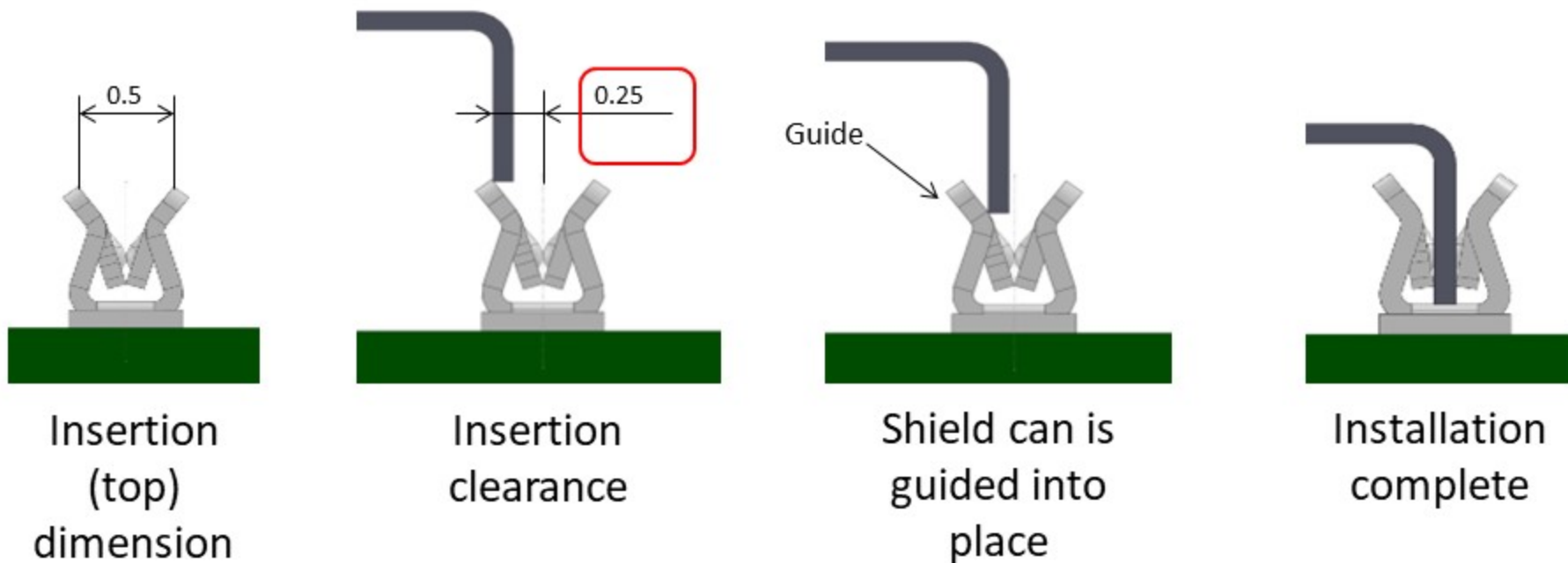
Before reflow



After reflow

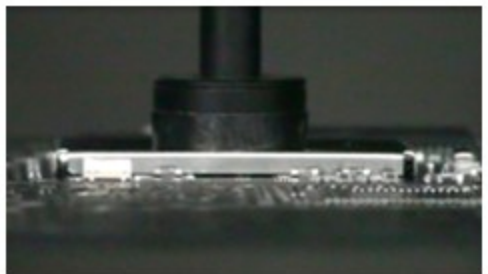
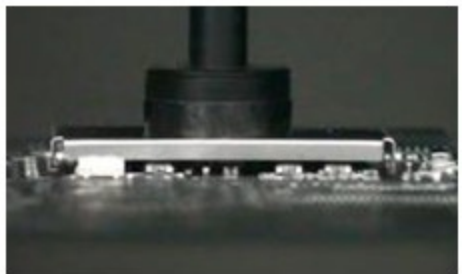


Shielding Can Clip Design

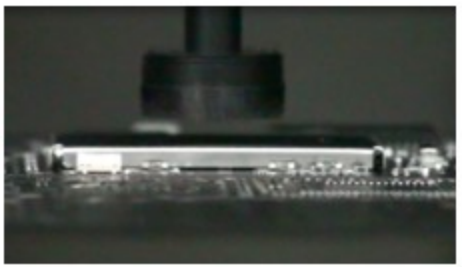


Designed with a wide opening on top to allow the shield cans to installed correctly without crushing or damaging the clip

Automated Shield Can Installation



*wide nozzle to accommodate the shield can's surface



Fuji Machine Mfg. Co., Ltd.
Pick-and-Place machine